

Product Specification

RoHS-6 Compliant Industrial Temperature 10Gb/s 10km XFP Optical Transceiver FTLX1413M3BTL

PRODUCT FEATURES

- Supports 8.5Gb/s to 11.3Gb/s bit rates
- Power dissipation <1.5W
- Extended temperature range: $-40 \, \text{C}$ to 85 $\, \text{C}$
- RoHS-6 Compliant (lead-free)
- Hot-pluggable XFP footprint
- Single Power supply: 3.3V
- Maximum link length of 10km
- Uncooled 1310nm DFB laser
- No Reference Clock required
- Built-in digital diagnostic functions



APPLICATIONS

- SONET/SDH OC-192 SR-1 ITU G.693, VSR2000-2R1
- 10GBASE-LR /LW 10G Ethernet
- 1200-SM-LL-L 10G Fibre Channel and 800-SM-LC-L 8G Fibre Channel
- ITU G.709 OTN/FEC OTU1e, OTU2, OTU2e
- 10G CPRI

Finisar's FTLX1413M3BTL **Industrial Temperature** Small Form Factor 10Gb/s (XFP) transceivers are compliant with the current XFP Multi-Source Agreement (MSA) Specification¹. They are a true multi-protocol transceiver complying with SONET OC-192 SR-1, SDH STM I-64.1, 10-Gigabit Ethernet 10GBASE-LR /LW per IEEE 802.3ae, 10G Fibre Channel 1200-SM-LL-L, 8G Fibre Channel 800-SM-LC-L, 10G CPRI, and ITU-T. G709 OTN/FEC protocols OTU1e, OTU2, and OTU2e. Digital diagnostics functions are available via a 2-wire serial interface, as specified in the XFP MSA. The optical transceiver is compliant per the RoHS Directive 2011/65/EU³. See Finisar Application Note AN-2038 for more details⁴.

PRODUCT SELECTION

FTLX1413M3BTL



I. Pin Descriptions

Pin	Logic	Symbol	Name/Description			
1		GND	Module Ground	1		
2		VEE5	Optional –5.2 Power Supply – Not required			
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module to			
			respond to 2-wire serial interface commands			
4	LVTTL-O	Indonesia 4	Interrupt (bar); Indicates presence of an important condition	2		
		Interrupt	which can be read over the serial 2-wire interface			
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off			
6		VCC5	+5 Power Supply– Not required			
7		GND	Module Ground	1		
8		VCC3	+3.3V Power Supply			
9		VCC3	+3.3V Power Supply			
10	LVTTL-I	SCL	Serial 2-wire interface clock	2		
11	LVTTL-	SDA	Serial 2-wire interface data line	2		
	I/O					
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded	2		
		_	in the module.			
13	LVTTL-O	Mod_NR	Module Not Ready; Finisar defines it as a logical OR	2		
		_	between RX_LOS and Loss of Lock in TX/RX.			
14	LVTTL-O	RX_LOS	Receiver Loss of Signal indicator	2		
15		GND	Module Ground	1		
16		GND	Module Ground	1		
17	CML-O	RD-	Receiver inverted data output			
18	CML-O	RD+	Receiver non-inverted data output			
19		GND	Module Ground	1		
20		VCC2	+1.8V Power Supply – Not required			
21	LVTTL-I	P Down/RST	Power Down; When high, places the module in the low			
		_	power stand-by mode and on the falling edge of P Down			
			initiates a module reset			
			Reset; The falling edge initiates a complete reset of the			
			module including the 2-wire serial interface, equivalent to a			
			power cycle.			
22		VCC2	+1.8V Power Supply – Not required			
23		GND	Module Ground	1		
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the	3		
			host board – Not required			
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host	3		
			board - Not required			
26		GND	Module Ground	1		
27		GND	Module Ground	1		
28	CML-I	TD-	Transmitter inverted data input			
29	CML-I	TD+	Transmitter non-inverted data input			
30		GND	Module Ground	1		

Notes:

- 1. Module circuit ground is isolated from module chassis ground within the module.
- 2. Open collector; should be pulled up with 4.7k 10kohms on host board to a voltage between 3.15V and 3.6V.
- 3. A Reference Clock input is not required by the FTLX1413M3BTL. If present, it will be ignored.



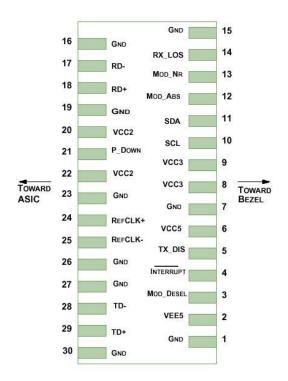


Diagram of Host Board Connector Block Pin Numbers and Name

II. Absolute Maximum Ratings

Parameter	Symbol	Min	Тур	Max	Unit	Ref.
Maximum Supply Voltage	Vcc3	-0.5		3.6	V	
Storage Temperature	T_{S}	-40		85	°C	
Case Operating Temperature	T_{OP}	-40		85	°C	



III. Electrical Characteristics ($T_{OP} = -40$ to 85 °C, $V_{CC3} = 3.13$ to 3.45 Volts)

Parameter	Symbol	Min	Тур	Max	Unit	Ref.
Supply Voltage	Vcc3	3.13		3.45	V	
Supply Current	Icc3			600	mA	
Module total power	P			1.5	W	1
Transmitter						
Input differential impedance	R _{in}		100		Ω	2
Differential data input swing	Vin,pp	120		820	mV	3
Transmit Disable Voltage	V_{D}	2.0		Vcc	V	4
Transmit Enable Voltage	V_{EN}	GND		GND+ 0.8	V	
Transmit Disable Assert Time				10	us	
Receiver						
Differential data output swing	Vout,pp	340	650	850	mV	5
Data output rise time	$t_{\rm r}$			38	ps	6
Data output fall time	t_{f}			38	ps	6
LOS Fault	$V_{LOS\ fault}$	Vcc - 0.5		Vcc_{HOST}	V	7
LOS Normal	V _{LOS norm}	GND		GND+0.5	V	7
Power Supply Rejection	PSR		See Not	e 8 below		8

Notes:

- 1. Maximum total power value is specified across the full temperature and voltage range.
- 2. After internal AC coupling.
- 3. SONET/SDH jitter generation requirements are guaranteed with a minimum differential data input swing of 500mV peak-to-peak.
- 4. Or open circuit.
- 5. Into 100 ohms differential termination.
- 6. 20 80 %
- 7. Loss Of Signal is open collector to be pulled up with a 4.7k 10kohm resistor to 3.15 3.6V. Logic 0 indicates normal operation; logic 1 indicates no signal detected.
- 8. Per Section 2.7.1. in the XFP MSA Specification¹.



IV. Optical Characteristics ($T_{OP} = -40 \text{ to } 85^{\circ}\text{C}$, $V_{CC3} = 3.13 \text{ to } 3.45 \text{ Volts}$)

Parameter	Symbol	Min	Тур	Max	Unit	Ref.
Transmitter						
Output Opt. Pwr:9/125 SMF	P _{OUT}	-6		-1	dBm	1
Optical Wavelength	λ	1290		1330	nm	
Optical Extinction Ratio	ER	6			dB	1
Sidemode Supression ratio	SSR_{min}	30			dB	
Tx Jitter (SONET/SDH) 20kHz-80MHz	Tx_{j1}			0.3	UI	
Tx Jitter (SONET/SDH) 4MHz – 80MHz	Tx_{j2}			0.1	UI	
Relative Intensity Noise	RIN			-130	dB/Hz	
Receiver						
Receiver Sensitivity @ 9.95Gb/s	R _{SENS1}			-14.4	dBm	
Receiver Sensitivity @ 10.5Gb/s	R _{SENS2}			-14.4	dBm	2
Receiver Sensitivity @ 11.3Gb/s	R _{SENS3}			-13.4	dBm	2
Stressed Receiver Sensitivity (OMA) @ 10.5Gb/s	R_{SENS4}			-10.3	dBm	3
Maximum Input Power	P_{MAX}	+0.5			dBm	
Optical Center Wavelength	λ_{C}	1260		1600	nm	
Receiver Reflectance	R_{rx}			-14	dB	
LOS De-Assert	LOS_D			-18	dBm	
LOS Assert	LOS_A	-32			dBm	
LOS Hysteresis		0.5			dB	

Notes:

- 1. Having ER = $6 \, dB$ guarantees that the $-6 \, dBm$ minimum output power meets IEEE 802.3ae requirement of OMA=-5.2dBm.
- 2. Measured with worst ER; BER $<10^{-12}$; $2^{31} 1$ PRBS. Complies with -12.6 dBm OMA at ER = 6 dB.
- 3. Per IEEE 802.3ae. Equivalent to -13.3 dBm average power at Infinite ER, -11.08 dBm at ER = 6 dB.

8.5Gb/s Fibre-Channel:

To operate the FTLX1413M3BTL at 8.5Gb/s Fibre-Channel, the EEPROM-Table 0, Byte 117, Bit 0 must be set as follows;

- EEPROM Byte 117, Bit 0, value "1" for 8GFC:
- EEPROM Byte 117, Bit 0 value "0" for 10Gb/s rates:
 - o (It is also possible to bypass the CDRs with, Byte 111, Bit 0.)

By default, a power cycling the transceiver will return the transceiver to normal 10Gb/s operation with the CDRs active.



V. General Specifications

Parameter	Symbol	Min	Тур	Max	Units	Ref.
Bit Rate	BR	8.5		11.3	Gb/s	1
Bit Error Ratio	BER			10 ⁻¹²		2
Max. Supported Link Length	L_{MAX}		10		km	1

- 1. SONET OC-192 SR-1, SDH STM I-64.1, 10GBASE-LR/LW, 1200-SM-LL-L, 800-SM-LC-L, SONET OC-192 with FEC, 10GBASE-LR/LW with FEC, 1200-SM-LL-L with FEC. 2. Tested with a $2^{31} - 1$ PRBS

VI. **Environmental Specifications**

Finisar FTLX1413M3BTL transceivers have an inductrial operating case temperature range of -40 $^{\circ}$ C to +85 $^{\circ}$ C.

Parameter	Symbol	Min	Тур	Max	Units	Ref.
Case Operating Temperature	T_{op}	-40		85	$\mathcal C$	
Storage Temperature	T_{sto}	-40		85	С	

VII. **Regulatory Compliance**

Finisar XFP transceivers are Class 1 Laser Products. They are certified per the following standards:

Feature	Agency	Standard	Certificate Number
Laser Eye Safety	FDA/CDRH	CDRH 21 CFR 1040 and Laser Notice 50	9210176-77
Laser Eye Safety	TÜV	EN 60825-1: 2007, EN60825-2:2004+A1 IEC 60825-1: 2007 (2 nd Edition) IEC 60825-2: 2010 (3 rd Edition)	R72101686
Electrical Safety	TÜV	EN 60950:2006+A11	R72101686
Electrical Safety	UL/CSA	CLASS 3862.07 CLASS 3862.87	2283290

Copies of the referenced certificates are available at Finisar Corporation upon request.



VIII. Digital Diagnostic Functions

As defined by the XFP MSA¹, Finisar XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

- Transceiver temperature
- Laser bias current
- Transmitted optical power
- Received optical power
- Transceiver supply voltage

It also provides a sophisticated system of alarm and warning flags, which may be used to alert end-users when particular operating parameters are outside of a factory-set normal range.

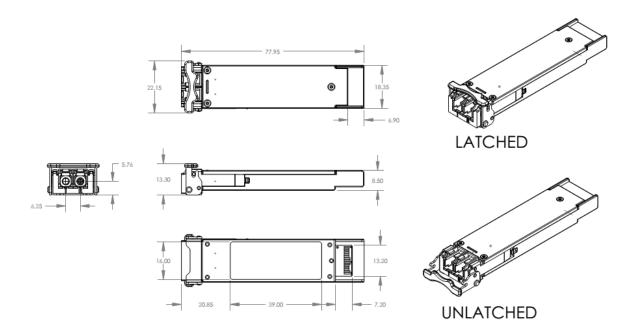
The operating and diagnostics information is monitored and reported by a Digital Diagnostics Transceiver Controller (DDTC) inside the transceiver, which is accessed through the 2-wire serial interface. When the serial protocol is activated, the serial clock signal (SCL pin) is generated by the host. The positive edge clocks data into the XFP transceiver into those segments of its memory map that are not write-protected. The negative edge clocks data from the XFP transceiver. The serial data signal (SDA pin) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially. The 2-wire serial interface provides sequential or random access to the 8 bit parameters, addressed from 000h to the maximum address of the memory.

For more detailed information including memory map definitions, please see Finisar Application Note AN-2035 "Digital Diagnostic Monitoring Interface for XFP Optical Transceivers", or the XFP MSA Specification¹.



IX. Mechanical Specifications

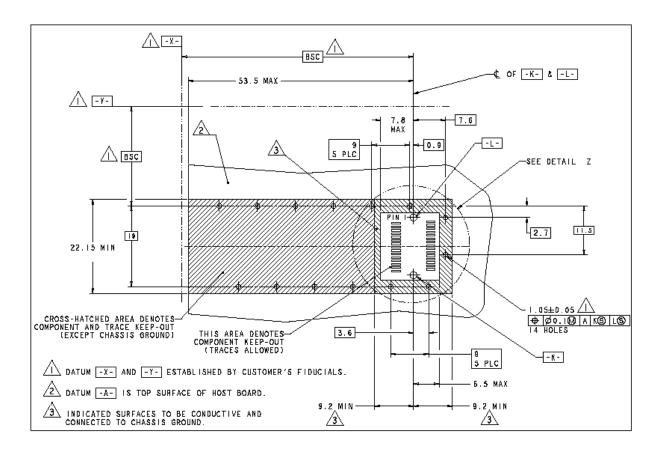
Finisar's XFP transceivers are compliant with the dimensions defined by the XFP Multi-Sourcing Agreement (MSA).



XFP Transceiver (dimensions are in mm)

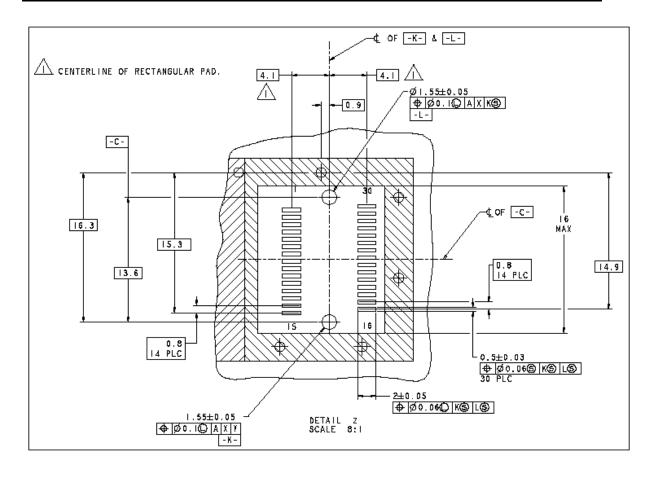


X. PCB Layout and Bezel Recommendations

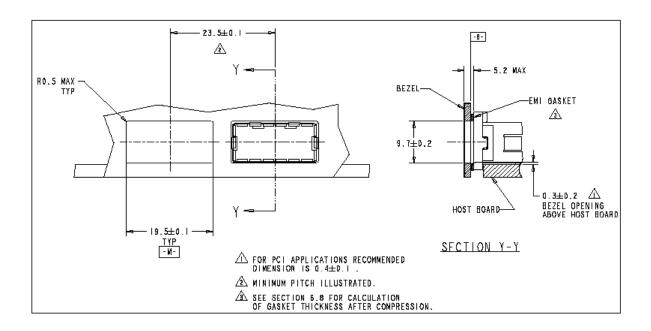


XFP Host Board Mechanical Layout (dimensions are in mm)





XFP Detail Host Board Mechanical Layout (dimensions are in mm)



XFP Recommended Bezel Design (dimensions are in mm)



XI. References

- 1. 10 Gigabit Small Form Factor Pluggable Module (XFP) Multi-Source Agreement (MSA), Rev 4.5 August 2005. Documentation is currently available at http://www.xfpmsa.org/
- 2. Application Note AN-2035: "Digital Diagnostic Monitoring Interface for XFP Optical Transceivers" Finisar Corporation, December 2003
- 3. Directive 2011/65/EU of the European Council Parliament and of the Council, "on the restriction of the use of certain hazardous substances in electrical and electronic equipment"
- 4. "Application Note AN-2038: Finisar Implementation Of RoHS Compliant Transceivers"

XII. For More Information

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